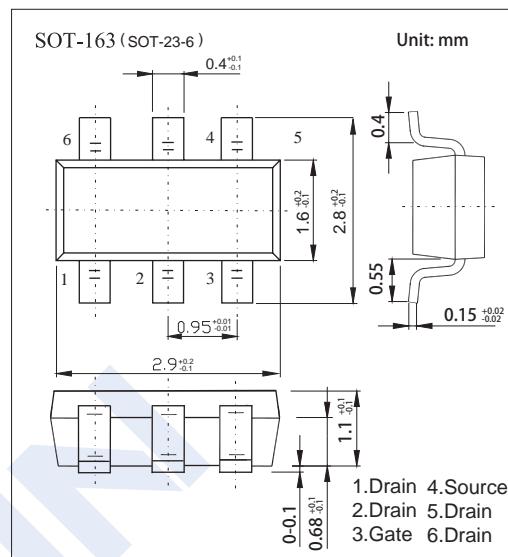
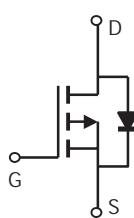


P-Channel Enhancement MOSFET

2KJ6015

■ Features

- $V_{DS}(V) = -30V$
- $I_D = -4.1 A$
- $R_{DS(ON)} < 52m\Omega$ ($V_{GS} = -10V$)
- $R_{DS(ON)} < 87m\Omega$ ($V_{GS} = -4.5V$)

■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current $T_a = 25^\circ C$	I_D	-4.1	A
$T_a = 70^\circ C$		-3.5	
Pulsed Drain Current	I_{DM}	-20	
Power Dissipation $T_a = 25^\circ C$	P_D	1.4	W
$T_a = 70^\circ C$		1	
Thermal Resistance.Junction- to-Ambient $t \leq 10s$	R_{thJA}	90	$^\circ C/W$
Steady State		125	
Thermal Resistance.Junction- to-Lead	R_{thJL}	60	
Junction Temperature	T_J	150	$^\circ C$
Storage Temperature Range	T_{stg}	-55 to 150	

P-Channel Enhancement MOSFET

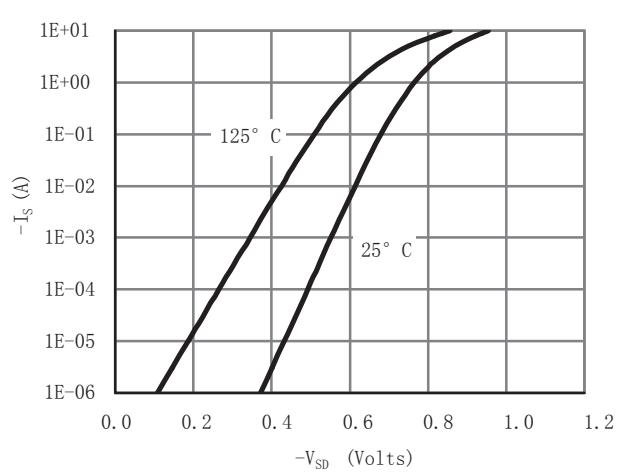
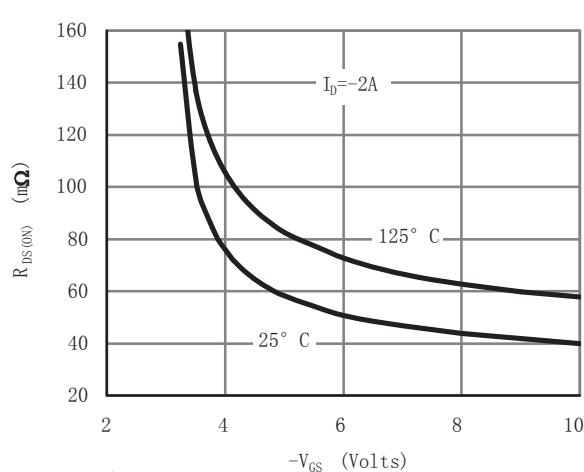
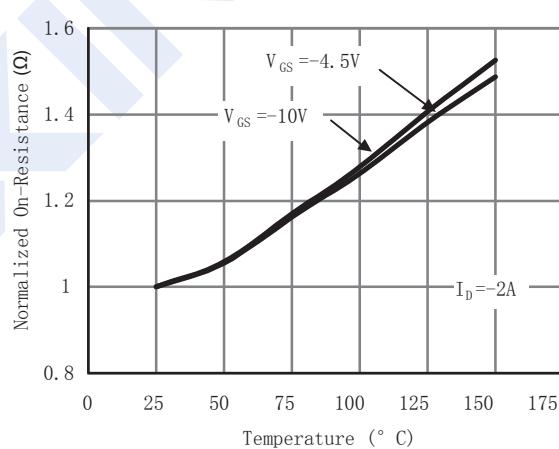
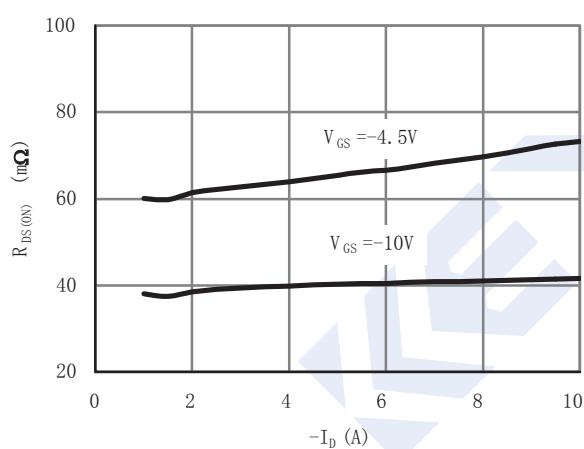
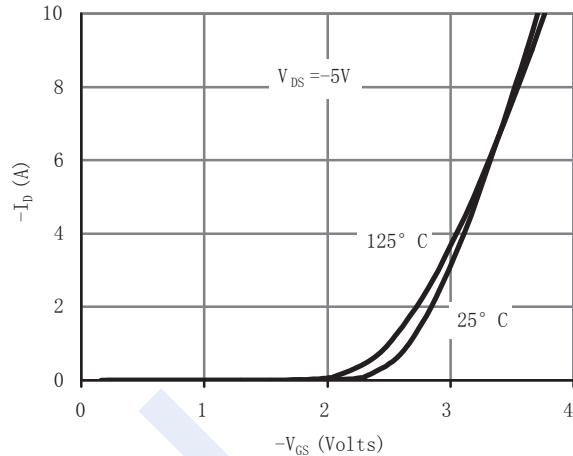
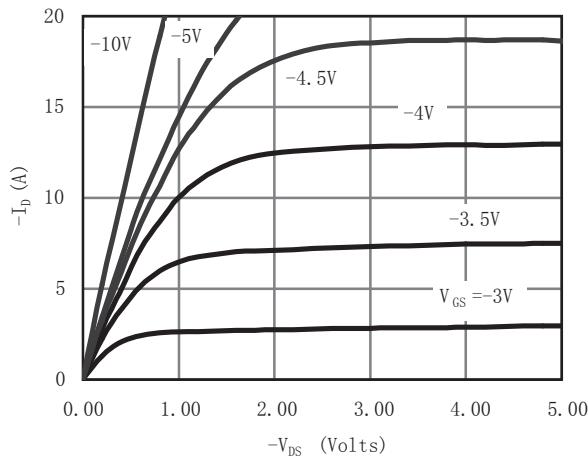
2KJ6015

■ Electrical Characteristics $T_a = 25^\circ\text{C}$

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V_{DSS}	$I_D = -250 \mu\text{A}, V_{GS} = 0\text{V}$	-30			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -24\text{V}, V_{GS} = 0\text{V}$			-1	μA
		$V_{DS} = -24\text{V}, V_{GS} = 0\text{V}, T_J = 55^\circ\text{C}$			-5	
Gate-Body leakage current	I_{GSS}	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$			± 100	nA
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$	-1	-1.8	-3	V
Static Drain-Source On-Resistance	$R_{DS(\text{on})}$	$V_{GS} = -10\text{V}, I_D = -4.1\text{A}$		40.5	52	$\text{m}\Omega$
		$V_{GS} = -10\text{V}, I_D = -4\text{A}, T_J = 125^\circ\text{C}$		57	73	
		$V_{GS} = -4.5\text{V}, I_D = -3\text{A}$		64	87	
On state drain current	$I_{D(\text{ON})}$	$V_{GS} = -4.5\text{V}, V_{DS} = -5\text{V}$	-10			A
Forward Transconductance	g_{FS}	$V_{DS} = -5\text{V}, I_D = -4\text{A}$	5.5	8.2		S
Input Capacitance	C_{iss}	$V_{GS} = 0\text{V}, V_{DS} = -15\text{V}, f = 1\text{MHz}$		700		pF
Output Capacitance	C_{oss}			120		
Reverse Transfer Capacitance	C_{rss}			75		
Gate resistance	R_g	$V_{GS} = 0\text{V}, V_{DS} = 0\text{V}, f = 1\text{MHz}$		10		Ω
Total Gate Charge	Q_g	$V_{GS} = -4.5\text{V}, V_{DS} = -15\text{V}, I_D = -4\text{A}$		14.3		nC
Gate Source Charge	Q_{gs}			7		
Gate Drain Charge	Q_{gd}			3.1		
Turn-On Delay Time	$t_{d(on)}$	$V_{GS} = -10\text{V}, V_{DS} = -15\text{V}, R_L = 3.6 \Omega, R_{GEN} = 3 \Omega$		8.6		ns
Turn-On Rise Time	t_r			5		
Turn-Off Delay Time	$t_{d(off)}$			28.2		
Turn-Off Fall Time	t_f			13.5		
Body Diode Reverse Recovery Time	t_{rr}			27		
Body Diode Reverse Recovery Charge	Q_{rr}	$I_F = -4\text{A}, dI/dt = 100\text{A}/\mu\text{s}$		15		nC
Maximum Body-Diode Continuous Current	I_S				-2.2	
Diode Forward Voltage	V_{SD}	$I_S = -1\text{A}, V_{GS} = 0\text{V}$		-0.77	-1	V

■ Marking

Marking	JAG
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P-Channel Enhancement MOSFET**2KJ6015****■ Typical Characteristics**

P-Channel Enhancement MOSFET

2KJ6015

■ Typical Characteristics

